

2816A/2816AH 5516A/5516AH

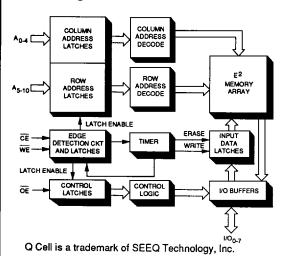
Timer E² 16K Electrically Erasable PROMs

August 1992

Features

- Military and Extended Temperature Range
 - - 55°C to + 125°C, Operation (Military)
 - · − 40°C to +85°C, Operation (Extended)
 - 0°C to +70°C, Operation (Commercial)
- End of Write Detection
 - · Optional DATA Polling Feature
- High Endurance Write Cycles
 - · 2816A: 10,000 Cycles/Byte Minimum
 - 5516A: 100K, 400K and 1 Million Cycles/Byte
- On-Chip Timer
 - · Automatic Erase and Write Time Out
- All Inputs Latched by Write or Chip Enable
- 5 V ± 10% Power Supply
- Power Up/Down Protection Circuitry
- 150 ns max, Access Time
- Low Power Operation
 - · 100 mA max. Active Current
 - · 40 mA max. Standby Current
- JEDEC Approved Byte-Wide Pinout
- MIL-STD-883 Class B Compliant

Block Diagram



Description

SEEQ's 2816A/5516A are 5V only, 2K x 8 electrically erasable programmable read only memories (EEPROMs). EEPROMs are ideal for applications which require nonvolatility and in-system data modification. The endurance, the minimum number of times that a byte may be written, is 10 thousand (K) for the 2816A, and 100K, 400K or 1 million cycles for the 5516A. The 5516A's high endurance was accomplished using SEEQ's proprietary oxyntride EEPROM process and its innovative Q CellTM design. The 2816A/5516A is ideal for systems that require frequent updates.

There is an internal timer that automatically times out the write time. A separate erase cycle is not required and the minimum write enable (WE) pulse width needs to be as little as 100 ns depending on device address access time.

Pin Configuration

PLASTIC LEADED

TOP VIE	W	CHIP CARRIER TOP VIEW
A ₇	24 VCC 23 A ₈ 22 A ₉ 21 WE 20 OE 19 A ₁₀ 18 CE 17 VC ₇ 16 VC ₆ 15 VC ₅ 14 VC ₄ 13 VC ₃	A 6 5 6 A 7 A 9 A 9 A 9 A 9 A 9 A 9 A 9 A 9 A 9

NOTE: For PLCC - Ready/Busy pin option is always connected unless otherwise specified.

Pin Names

DUAL-IN-LINE

A ₀ -A ₁₀	ADDRESSES
CE	CHIP ENABLE
ŌĒ	OUTPUT ENABLE
WE	WRITE ENABLE
I/O ₀₋₇	DATA INPUT (WRITE OR ERASE) DATA OUTPUT (READ)



The on-chip timer, along with the inputs being latched by a write or chip enable signal edge, frees the microcomputer system for other tasks during the write time. The standard 2816A/5516A's write time is 10 ms, while the 2816AH/5516AH write time is a fast 2ms. Once a byte is written, it can be read in a maximum of 150 ns. The inputs are TTL for both the byte write and read mode.

Device Operation

There are five operational modes (see Table 1) and, except for the chip erase mode [1], only TTL inputs are required. To write into a particular location, a TTL low is applied to write enable (WE) pin of a selected (CE low) device. This, combined with output enable (OE) being high, initiates a write cycle. During a byte write cycle, addresses are latched on the last falling edge of CE or WE and data is latched on the first rising edge of CE or WE. An internal timer times out the required byte write time. An automatic byte erase is performed internally in the byte write mode.

DATA Polling (Optional Feature)

DATA polling is a method of minimizing write times by determining the actual end-point of a write cycle. If a read is performed to any address while the device is still writing, it will present the ones-complement of the last byte written. When the device has completed its write cycle, a read from the last address written will result in valid data. Thus, software can simply read from the part until the last data byte written is read correctly. Timing for a DATA polling read is the same as a normal read.

Mode Selection (Table 1)

Mode	CE	ŌĒ	WE	1/0
Read	V _{IL}	VIL	V _{IH}	D _{out}
Standby	V _{iH}	Х	Х	High Z
Byte Write	V _{IL}	V _{IH}	V _{IL}	D _{IN}
Write Inhibit	X	V _{IL}	X V _{IH}	High Z/D _{out} High Z/D _{out}

X: any TTL level

Absolute Maximum Stress Ratings*

Temperature
Storage65°C to +150°C
Under Bias
Military/Extended65° C to +135° C
Commercial10° C to +80° C
D.C. Voltage applied to all Inputs or Outputs
with respect to ground+6.0 V to -0.5 V
Undershoot/Overshoot pulse of less then 10 ns
(measured at 50% point) applied to all inputs or
outputs with respect to ground (undershoot) -1.0 V
(overshoot) + 7.0 V

"COMMENT: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Recommended Operating Conditions

		2816A/2816AH-150 5516A/5516AH-150	2816A/2816AH-200 5516A/5516AH-200	2816A/2816AH-250 5516A/5516AH-250	2816A/2816AH-300 5516A/5516AH-300
Temperature	Commercial	0°C to +70°C	0°C to +70°C	0°C to +70°C	0°C to +70°C
Range	Extended	-40°C to +85°C	-40°C to +85°C	-40°C to +85°C	-40°C to +85°C
	Military	-55°C to +125°C	-55°C to +125°C	-55°C to +125°C	-55°C to +125°C
V _{cc} Supply Voltage		5V±10%	5V±10%	5V±10%	5V±10%

Endurance and Data Retention

Symbol	Parameter	Value	Units	Condition	
N	Minimum Endurance 2816A	10,000	Cycles/Byte	MIL-STD 883 Test Method 1033	
	5516A	100,000 400,000 1,000,000	Cycles/Byte	MIL-STD 883 Test Method 1033	
T _{DR}	Data Retention	>10	Years	MIL-STD 883 Test Method 1033	

Notes:

- 1. Chip Erase is an optional mode.
- 2. Characterized. Not tested.



Power Up/Down Considerations

The 2816A/5516A has internal circuitry to minimize a false write during system $V_{\rm CC}$ power up or down. This circuitry prevents writing under any one of the following conditions.

- 1. V_{cc} is less than 3V.[2]
- A negative Write Enable (WE) transition has not occured when V_{cc} is between 3 V and 5 V.

Writing will also be prevented if \overrightarrow{CE} or \overrightarrow{OE} are in a logical state other than that specified for a byte write in the Mode Selection table.

DC Operating Characteristics (Over the operating V_{cc} and temperature range)

	Parameter	Lit	nits		
Symbol		Min.	Max.	Units	Test Condition
00	Active V _{cc} Current	_	100	mA	CE = OE =V _{IL} ; All I/O Open; Other Inputs = 5.5 V
		_			CE = OE ±V _{IL} ; All I/O Open; Other Inputs = 5.5 V
I _{se}	Standby V _{cc} Current		40	mA	CE = V _{IH} , OE = V _{IL} ; All I/O's Open; Other Inputs = 5.5 V
l _u	Input Leakage Current		10	μА	V _{IN} = 5.5 V
I _{LO}	Output Leakage Current		10	μА	V _{OUT} = 5.5 V
V_{iL}	Input Low Voltage	-0.1	0.8	٧	
V _{IH}	Input High Voltage	2.0	6	V	
V _{OL}	Output Low Voltage		0.4	٧	I _{oL} = 2.1 mA
V _{oh}	Output High Voltage	2.4		٧	I _{OH} = -400 μA

Capacitance [1] TA = 25°C, f = 1 MHz

Symbol	Parameter	Max	Conditions
CIN	Input Capacitance	6 pF	V _{IN} = 0 V
C _{out}	Data (I/O) Capacitance	10 pF	V _{I/O} = 0 V

NOTES:

1. This parameter measured only for the initial qualification and after process or design changes which may affect capacitance.

Equivalent A.C. Test Conditions

Output Load: 1 TTL gate and C_L = 100 pF Input Rise and Fall Times: < 20 ns Input Pulse Levels: 0.45 V to 2.4 V Timing Measurement Reference Level: Inputs 1 V and 2 V Outputs 0.8 V and 2 V

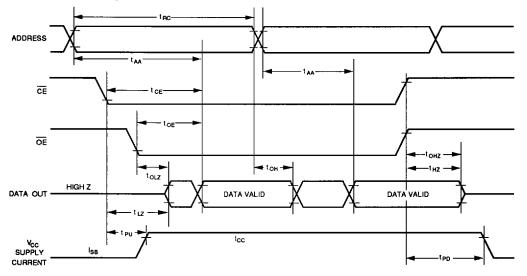


AC Characteristics

Read Operation (Over the operating V_{cc} and temperature range)

		Limits									
					2816A/2816AH-200 5516A/5516AH-200			2816A/2816AH-300 5516A/5516AH-300			
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Units	
t _{RC}	Read Cycle Time	150		200		250		300		ns	
t _{ce}	Chip Enable Access Time		150		200		250		300	ns	
t _{AA}	Address Access Time		150		200		250		300	ns	
toE	Output Enable Access Time		70		90		90		100	ns	
t _{LZ}	CE to Output in Low Z	10		10		10		10		ns	
t _{HZ}	CE to Output in High Z		100		100		100		100	ns	
t _{oLZ}	OE to Output in Low Z	50		50		50		50		ns	
tonz	OE to Output in High Z		100		100		100		100	ns	
t _{он} [1]	Output Hold from Addr Change	20		20		20		20		ns	
t _{PU} [1]	CE to Power-up Time	0		0		0		0		ns	
t _{PD} ⁽¹⁾	CE to Power Down Time		50		50		50		50	ns	

Read Cycle Timing





NOTES:
1. This parameter measured only for the initial qualification and after process or design changes which may affect capacitance.

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$\textbf{\textit{AC Characteristics}} \quad \textbf{Write Operation} \ \, (\textbf{Over the operating V}_{\texttt{cc}} \ \, \textbf{and temperature range})$

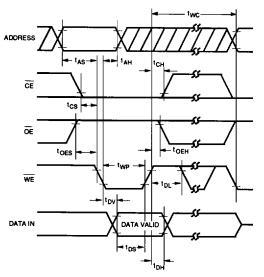
		Limits								
		2816A/ 5516A/	2816A/AH-200 5516A/AH-200		2816A/AH-250 5516A/AH-250		2816A/AH-300 5516A/AH-300			
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Units
twc	Write Cycle Time									
	2816AH/5516AH		2		2		2		2	ms
	2816A/5516A		10		10		10		10	ms
t _{AS}	Address Set Up Time	10		10		10		10		ns
t _{AH}	Address Hold Time	50		50		50		70		ns
t _{cs}	Write Set Up Time	0		0		0		0		ns
t _{ch}	Write Hold Time	0		0		0		0		ns
t _{cw}	CE to End of Write Input	150		150		150		150		ns
t _{oes}	OE Set Up Time	10		10		10		10		ns
t _{OEH}	OE Hold Time	10		10		10		10		ns
t _{we} [1]	WE Write Pulse Width	100		150		150		150		ns
t _{DL}	Data Latch Time	50		50		50		50		ns
t _{ov} [2]	Data Valid Time		1		1		1		1	μs
t _{os}	Data Set Up Time	50		50		50		50		ns
t _{DH}	Data Hold Time	0		0		0		0		ns

NOTES:

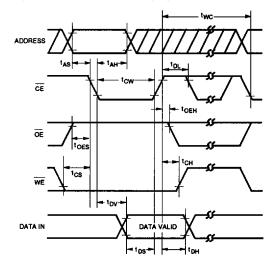
- 1. WE is noise protected. Less than a 20 ns write pulse will not activate a write cycle.
- 2. Data must be valid within 1 us maximum after the initiation of a write cycle.

TTL Byte Write Cycle

WE CONTROLLED WRITE CYCLE



CE CONTROLLED WRITE CYCLE





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Ordering Information

